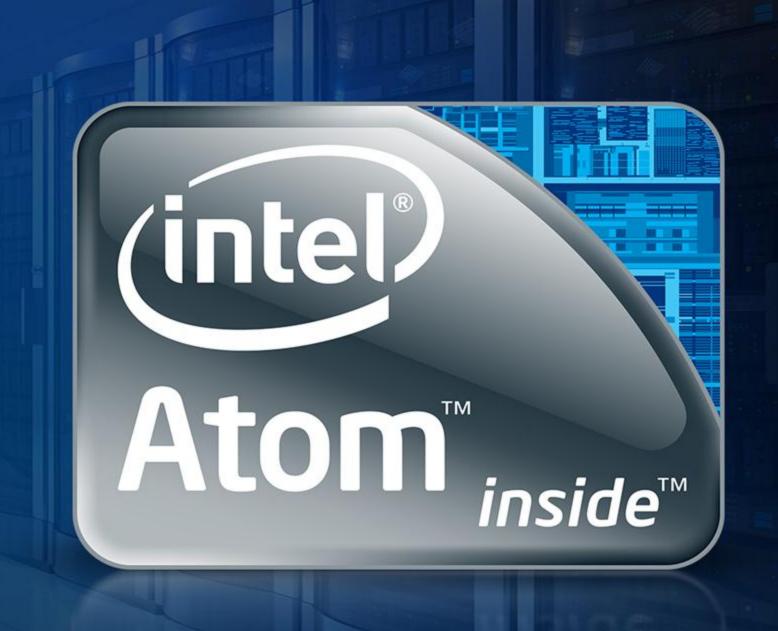
Introducing the First Datacenter Atom[™] SOC

Diane Bryant

Intel® Vice President, General Manager, Datacenter & Connected Systems Group, Intel

Jason Waxman

General Manager, Cloud Platform Group, Intel December 11, 2012



Today's News

Intel delivers world's first 6W, 64 bit SoC for datacenters

>20 Intel® Atom™ design wins Microserver, storage and comms

New Atom SoC extends Intel's breadth of application optimized datacenter products



TCO a Universal Focus... Metric Varies by Segment

Enterprise IT



KEY METRICS:

Utilization, reliability & OpEx per app

Technical Computing



KEY METRICS:

FLOPS per dollar, FLOPS per Watt

Cloud SPs



KEY METRICS:

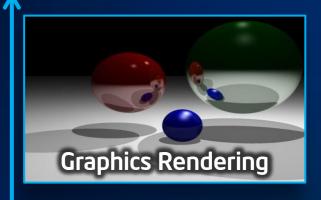
Perf per CapEx, Perf per Watt, consistency



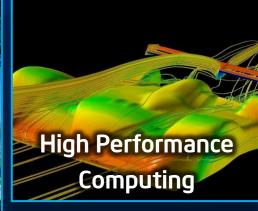
CPU Intensive

Workload Spectrum

Memory Intensive















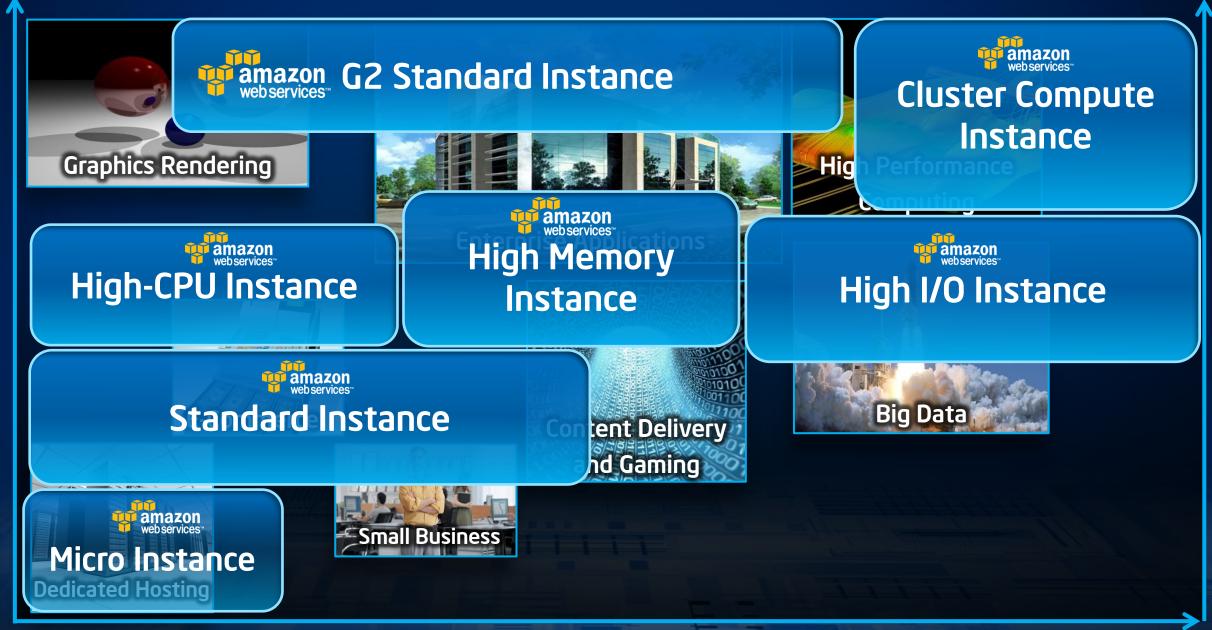




CPU Intensive

Workload Spectrum

Memory Intensive



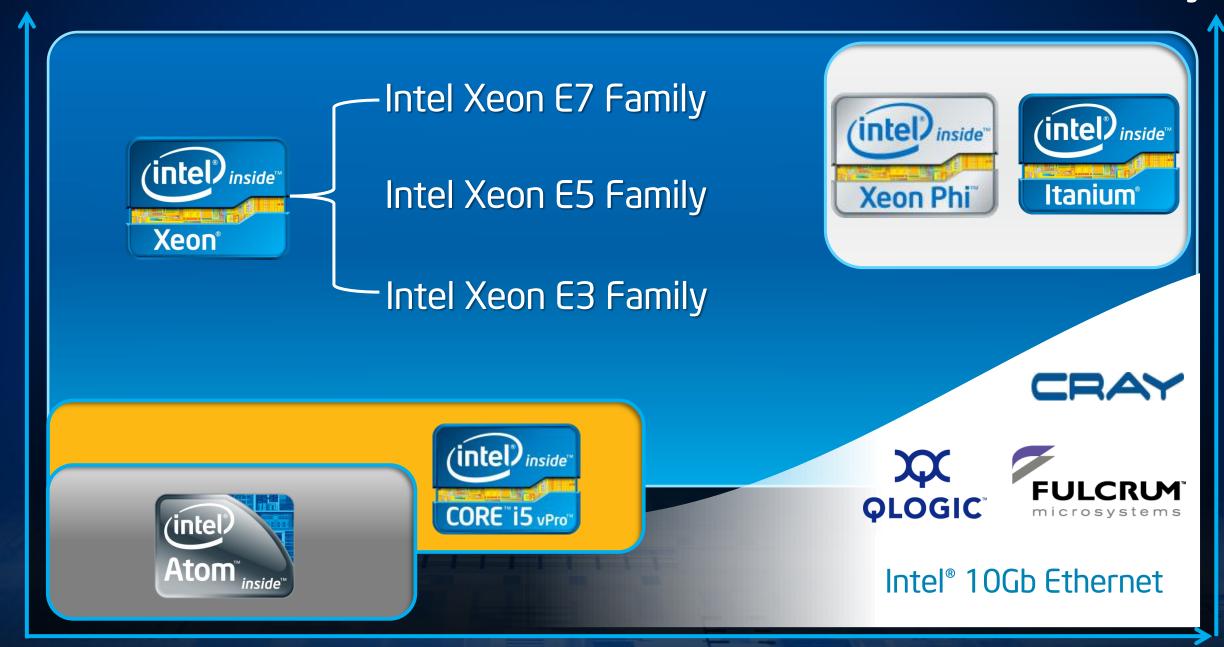




CPU Intensive

Diverse Infrastructure

Memory Intensive





Intel® Atom™ for the Datacenter

Right sized processing for specific workloads and deployment models

Microservers



EXAMPLE:Dedicated web hosting

Communications



EXAMPLE:Basic L2 Switching

Storage



EXAMPLE: Low end storage

> 20 Design Wins

























As Energy Cost Spiral, Intel Launches

Low Power Chips, Microservers

Sept. 22, 2009

Intel In Microservers

2010

2011

2012



INITIAL CONCEPT



GEN 1

2 Commercial **Systems**



GEN 2

5 Commercial **Systems**



GEN 3

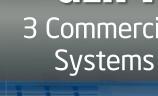
6 Commercial **Systems**





GEN 1 3 Commercial



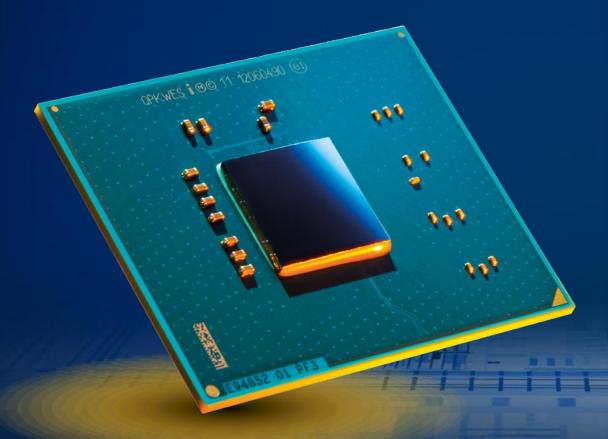




Intel® Atom™ Processor S1200 "World's First 64 bit, 6 Watt Datacenter Class SoC"

SHIPPING NOW!

Intel® Atom™ Processor S1200



Low Power

6 Watt TDP
 2 cores with Intel® Hyper Threading Technology

Datacenter Class

- 64 bit
- ECC Memory
- Intel[®] Virtualization Technology

High Density

• 1000+ nodes per rack

IA Software Compatibility

Leverages Existing SW Ecosystem



Example: Two Types of Web Serving Needs

Comparing a high throughput web tier to a dedicated web hoster



Maximum Web Transactions

Xeon®

UP TO 2X MORE
Web Trans/Min/Rack

Est. Intel CPU Revenue \$32.9K Maximum Web Servers

> Atom™ S1200



UP TO 5X MORE
Dedicated Nodes/Rack

Est. Intel CPU Revenue \$35.8K



The next disruptive wave of computing

Paul Santeler

VP of Hyperscale Business Unit, Industry Standard Servers

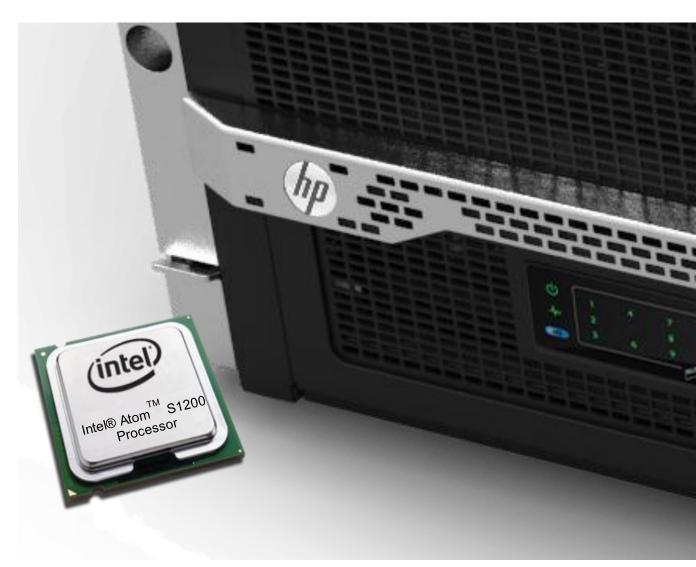


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HP revolutionizing scale-out data centers

First Moonshot production system, 'Gemini', featuring Intel® Atom™ processor

- Low power and ultra high density
- Rich, Datacenter-class features:
 - 64-bit support
 - Virtualization technology
 - ECC (error correcting code) memory
- Broad software ecosystem and consistent management
- Shipping customer evaluation <u>units</u> today

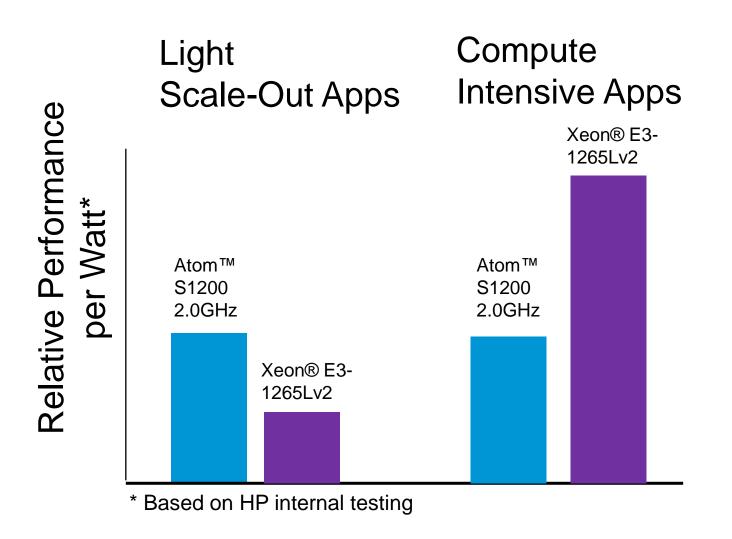


HP & Intel: Proven industry leadership and partnership



Maximize efficiency for scale-out applications

Extreme-low-energy Intel® AtomTM processors significantly improve power efficiencies



Most suitable for light Scale-Out applications

- Simple content delivery
- Large distributed memory caching
- Big-data simple search systems
- MapReduce applications





"LeaseWeb continuously innovates its product portfolio and services. That's why we tested an HP Gemini beta system with the Intel® Atom™ S1200 product family, and compared it with our Dedicated Server products. We are intrigued with the balance between power, performance and 64-bit software ecosystem support. Based on what we have seen so far, HP appears to have developed a highly efficient solution that is ideal for light scale-out workloads."

Marc Burkels

Manager Dedicated Servers and Colocation





Let our innovations power yours - enabling world's most efficient Datacenter

- Industry's first comprehensive program to unlock savings of extreme low energy servers
- From ten's of servers per rack sharing nothing to thousands per rack sharing everything
- Radical savings at scale for select workloads and applications

Atom Leverages Existing Software Ecosystem

15M Developers Building IA SOFTWARE **sec** redhat.

"Long-standing optimization on Intel Xeon processors extends today to the Intel Atom S1200 processor. With a single code base, Intel and Red Hat deliver the binary compatibility needed to run the most complex customer applications unchanged."

- Jim Totton, VP & GM, Platform Business Unit, Red Hat

18,000
Members of the Intel Software Partners Program

ORACLE

"Software compatibility between Intel® AtomTM S1200 Processor and Intel® Xeon processors provides customers with a seamless growth path. Writing and running a single code base across the broad range of Intel's x86 platforms sidesteps costly Software overhauls and delivers huge value for us and our customers"

- Ashok Joshi, Sr. Director Oracle NoSQL Database



and



Jeffrey Snover

Distinguished Engineer
Windows Server Lead Architect



Windows Server 2012



Committed To Leadership Roadmap

Today

2013

2014+



E3 v2 family 45-17 Watt E3 v3 Family (Haswell)

22nm

Next Gen 14nm



Intel® Atom™ S1200 6 Watt Avoton **22nm**

Next Gen 14nm Performance/Watt

Low Power

Density

Available Now



facebook

Frank Frankovsky

Vice President, Hardware Design and Supply Chain



1 billion users

140+ billion friend connections

220+ billion photos

300+ million photos added per day

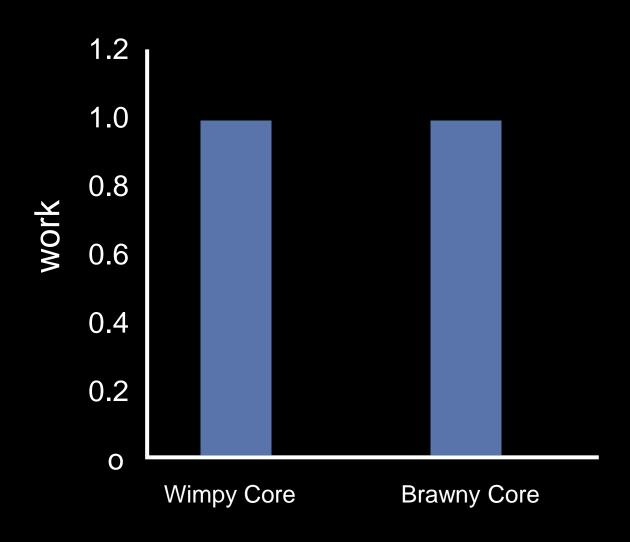
4.5 billion likes, posts, comments, and photos added per day

17 billion check-ins

Yep, that's a lot of compute power

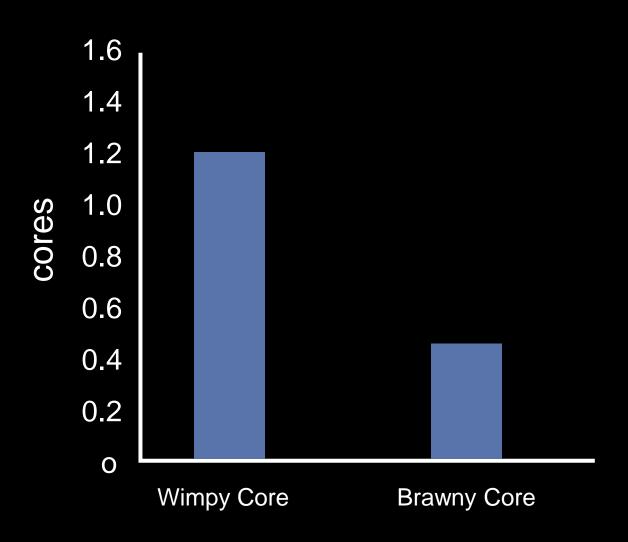
Computing Power

work - normalized



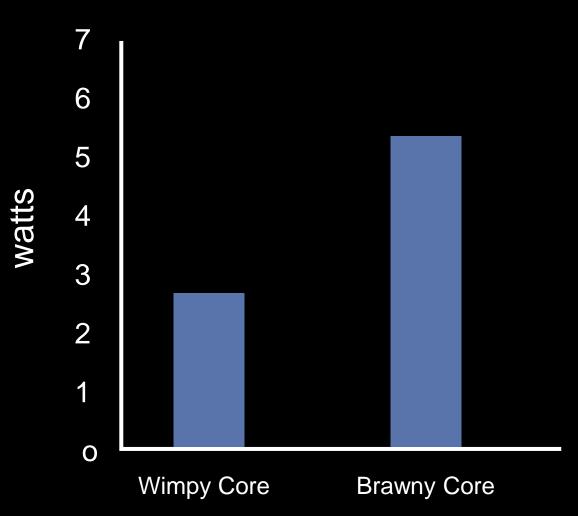
Cores Required





Watts Required





Facing unprecedented scale requirements

Excited about the potential of SOCs

It's all about useful work per watt per dollar!

facebook

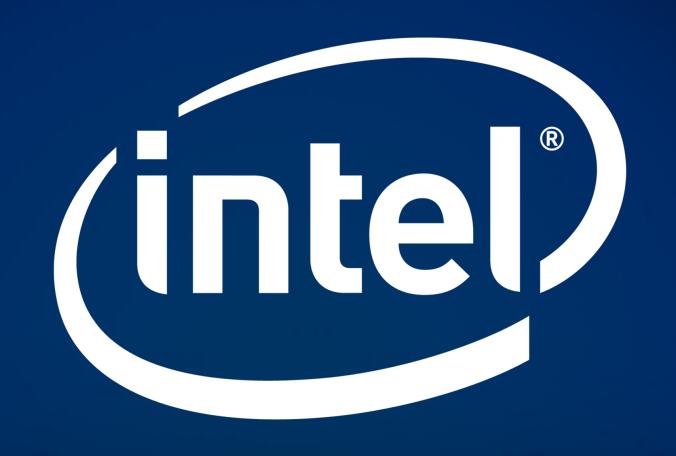
Summary

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New Atom SoC extends Intel's breadth of application optimized datacenter products





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Hyper Threading Technology requires a computer system with a processor supporting HT Technology and applied chipset. PIOS and appreciage system. Performance will year depending

Hyper-Threading Technology requires a computer system with a processor supporting HT Technology and an HT Technology-enabled chipset, BIOS and operating system. Performance will vary depending on the specific hardware

and software you use. For more information including details on which processors support HT Technology, see here

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No computer system can provide absolute security under all conditions. Intel® Trusted Execution Technology (Intel® TXT) requires a computer system with Intel® Virtualization Technology, an Intel TXT-enabled processor, chipset,

BIOS, authenticated Code Modules and an Intel TXT-compatible measured launched environment (MLE). The MLE could consist of a virtual machine monitor, an OS or an application. In addition, Intel TXT requires the system to

contain a TPM v1.2,as defined by the Trusted Computing Group and specific software for some uses. For more information, see he

The original equipment manufacturer must provide TPM functionality, which requires a TPM-supported BIOS. TPM functionality must be initialized and may not be available in all countries.

Roadmap not reflective of exact launch granularity and timing - please refer to ILU guidance

Intel® Virtualization Technology requires a computer system with an enabled Intel® processor, BIOS, virtual machine monitor (VMM). Functionality, performance or other benefits will vary depending on hardware and software

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Intel® AES-NI requires a computer system with an AES-NI enabled processor, as well as non-Intel software to execute the instructions in the correct sequence. AES-NI is available on select Intel® processors. For availability, consult

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Legal Information: Performance & Density Configuration

Metric	E3-1265Lv2	Atom S1260	<u>Difference</u>
SPECWeb/node	15,303	1,522	E3-1265Lv2 estimated node performance is 10X higher vs. Atom S1260
SPECWeb/rack	1,713,986	852,320	E3-1265Lv2 estimated rack performance is 2X higher vs. Atom S1260 rack
Nodes	112 (space limited)	560	Atom S1260 density is estimated 5X higher per rack
Power/node	60W	20W	Intel estimates based on CPU TDP, chipset (for E), memory, network interface,
			HDD and amortized power for fans and PSU

E3-1265Lv2 uSvr:

Dell* C5220* blade with Dell Viking Chassis

112 nodes per rack (14 chassis/rack * 8 blades/chassis) with 16GB DDR3, 2x10GbE, 2x480GB SSD per node.

Atom S1260 uSvr:

Assumed 560 nodes per rack (well within 15kW envelope) with 8GB DDR3, 2x1GbE, 2x150GB SSD per node.



